

TDA18214

Silicon tuner for digital terrestrial and cable TV reception

Rev. 1 — 13 July 2012

Preliminary short data sheet

1. General description

The TDA18214AHN and TDA18214HN are high performance silicon tuners designed for digital terrestrial and digital cable TV reception.

The TDA18214AHN and TDA18214HN support all digital TV standards and deliver a Low IF (LIF) signal to a demodulator.

The TDA18214AHN and TDA18214HN facilitate STB design by:

- Allowing on-board integration
- Drastically reducing the tuner Bill Of Material (BOM)
- Providing flexibility in system solution development
- Allowing straightforward, cost effective dual and multi-tuner applications optimization

In multi-tuner application, the TDA18214AHN is the master tuner whereas the TDA18214HN is a slave tuner.

2. Features and benefits

- Single 3.3 V supply voltage
- Worldwide multistandard digital terrestrial and digital cable capabilities
- Alignment free
- RoHS compliant
- I²C-bus interface compatible with 3.3 V microcontrollers
- Crystal oscillator output buffer
- Slave Tuner Output (STO) for multi-tuner applications (TDA18214AHN only)
- Fully integrated oscillators
- 2 programmable General-Purpose Outputs (GPO)
- Loop-Through Output (LTO)
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- LIF channel center frequency output ranging from 0.8 MHz to 7.5 MHz
- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Large flexibility in the IF filtering stage to ease the matching with various demodulators circuits
- Single-ended RF input, no need for external balun
- Up to 1 GHz RF input capability
- Excellent return loss compatible with cable requirements
- Power Level Detector (PLD) embedded
- Integrated gain control



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- Very fast tuning time
- Strong immunity to LTE interferers in the digital dividend bandwidth
- Strong immunity to WLAN interferers

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f_{RF}	RF frequency	full range of RF input	42	-	1002	MHz
NF _{tun}	tuner noise figure	75 Ω impedance source; maximum gain				
		LNA Z _i = 1 and RF < 870 MHz	-	4.0	4.6	dB
		LNA Z _i = 1 and 870 MHz < RF < 1 GHz	-	5.4	6	dB
Φjit	phase jitter	integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree
$lpha_{ ext{image}}$	image rejection	worst case, measured at 4 MHz IF frequency and for image levels above $60~dB_{\mu}V$	57.5	63	-	dB
CSO	composite second-order distortion	worst interferer over RF frequency with respect to wanted carrier	[1] _	-60	-50	dBc
СТВ	composite triple beat	worst interferer over RF frequency with respect to wanted carrier for frequency ≤ 550 MHz	[1] -	-65	-60	dBc
		worst interferer over RF frequency with respect to wanted carrier for frequency > 550 MHz	[1] -	-	-55	dBc
ICP _{1dB}	1 dB input compression point	at the tuner input and minimum gain	120	-	-	dBμV

^[1] Test scenario: 129 channels each 75 dB μ V.

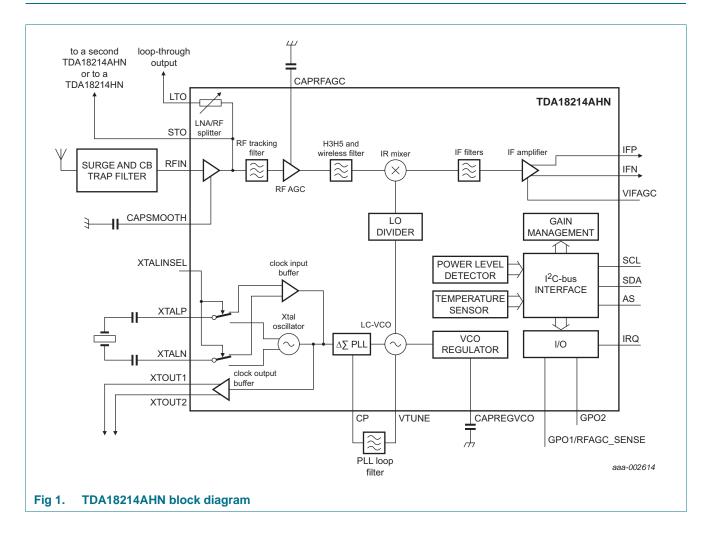
4. Ordering information

Table 2. Ordering information

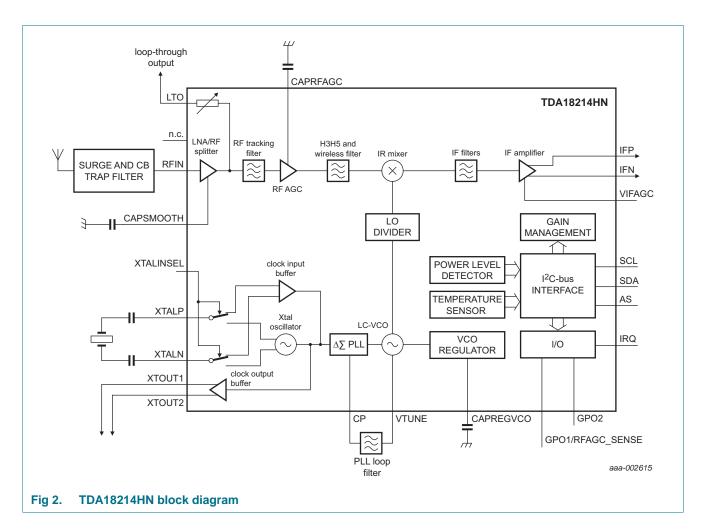
Type number	Package			
	Name	Description	Version	
TDA18214AHN/C1	HVQFN40	plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body $6\times6\times0.85$ mm	SOT618-6	
TDA18214HN/C1	_			

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5. Block diagram



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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.3	+3.6	V
V _I input voltage	nput voltage	V _{CC} < 3.3 V	-0.3	$V_{CC} + 0.3$	V
		V _{CC} > 3.3 V	-0.3	+3.6	V
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-20	<u>[1]</u>	°C
V _{ESD} electrostatic discharge volta	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III[2]	750	-	V
GPO pin	s: GPO1/RFAGC_SENSE and G	PO2			
V _{CC}	supply voltage	$0 \text{ V} < \text{V}_{\text{pu}} < 5.5 \text{ V}; \text{R}_{\text{pu}} > 390 \Omega$	-0.3	+5.5	V
I _{CC}	supply current	corresponding GPO ON	-20	0	mA

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- [1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I^2C -bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$. where $\Delta T_{j-c} = power \times R_{th}$.
- [2] Class III: 500 V to 1000 V.

7. Abbreviations

Table 4. Abbreviations

Acronym	Description
AGC	Automatic Gain Control
BOM	Bill Of Material
FCDM	Field-induced Charged-Device Model
GPO	General Purpose Outputs
H3H5	Harmonic 3 and Harmonic 5
HBM	Human Body Model
IF	Intermediate Frequency
I/O	Input/Output
LC-VCO	Inductors and Capacitors - Voltage Controlled Oscillator
LIF	Low IF
LNA	Low-Noise Amplifier
LO	Local Oscillator
LTE	Long-Term Evolution
LTO	Loop-Through Output
PLD	Power Level Detector
PLL	Phase-Locked Loop
RF	Radio Frequency
RoHS	Restriction of Hazardous Substances
SAW	Surface Acoustic Wave
STB	Set-Top Box
STO	Slave Tuner Output
VCO	Voltage Controlled Oscillator
Xtal	Crystal
WLAN	Wireless Local Area Network

8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA18214_SDS v.1	20120713	Preliminary short data sheet	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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